

K42A12N1-VB Datasheet N-Channel 100-V (D-S) MOSFET

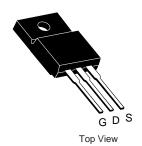
| PRODUCT SUMMARY | | | | | |
|---------------------|----------------------------------|--------------------|--|--|--|
| V _{DS} (V) | $R_{DS(on)}(\Omega)$ | I _D (A) | | | |
| 100 | 0.0085 at V _{GS} = 10 V | 90 | | | |
| 100 | 0.0100 at V _{GS} = 6 V | 85 | | | |

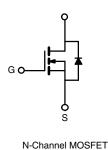
FEATURES

- TrenchFET® Power MOSFET
- 175 °C Maximum Junction Temperature
- Compliant to RoHS Directive 2002/95/EC









| ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted | | | | | | |
|---|----------------------------------|-----------------------------------|-----------------|------|--|--|
| Parameter | | Symbol | Limit | Unit | | |
| Drain-Source Voltage | | | 100 | V | | |
| Gate-Source Voltage | | | ± 20 | V | | |
| Continuous Drain Current (T _J = 150 °C) | T _C = 25 °C | I _D | 90 | | | |
| | T _C = 125 °C | | 70 ^a | Α | | |
| Pulsed Drain Current | I _{DM} | 287 | A | | | |
| Avalanche Current | L = 0.1 mH | I _{AS} | 75 | | | |
| Single Pulse Avalanche Energy ^b | L = 0.1 IIII I | E _{AS} | 280 | mJ | | |
| h | T _C = 25 °C (TO-220F) | P _D | 56 | W | | |
| Maximum Power Dissipation ^b | T _A = 25 °C (TO-220F) | | 3.75 | VV | | |
| Operating Junction and Storage Temperatu | ire Range | T _J , T _{stg} | - 55 to 175 | °C | | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|----------------------------|----------------------|-------------------|-------|------|--|--|
| Parameter | | Symbol | Limit | Unit | | |
| Junction-to-Ambient | PCB Mount (TO-220) d | R _{thJA} | 40 | | | |
| Junction-to-Ambient | Free Air (TO-220) | ' 'thJA | 62.5 | °C/W | | |
| Junction-to-Case | | R _{thJC} | 0.6 | | | |

Notes

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

服务热线:400-655-8788

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| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|---|--|---|------|--------|-------|------|--|
| Static | | | | • | | | |
| Drain-Source Breakdown Voltage | V _{DS} V _{GS} = 0 V, I _D = 250 μA 100 | | | | V | | |
| Gate-Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | 1 | | 3 | V | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA | |
| | | V _{DS} = 100 V, V _{GS} = 0 V | | | 1 | | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 100 V, V _{GS} = 0 V, T _J = 125 °C | | | 50 | μΑ | |
| | | V _{DS} = 100 V, V _{GS} = 0 V, T _J = 175 °C | | | 250 | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} = \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$ | 120 | | | Α | |
| | | V _{GS} = 10 V, I _D = 30 A | | 0.0085 | | | |
| | Ь | V _{GS} = 6 V, I _D = 20 A | | 0.0100 | | Ω | |
| Drain-Source On-State Resistance ^a | H _{DS(on)} | V _{GS} = 10 V, I _D = 30 A, T _J = 125 °C | | 0.0160 | | | |
| | | V _{GS} = 10 V, I _D = 30 A, T _J = 175 °C | | 0.0210 | | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = 15 V, I _D = 30 A | 25 | | | S | |
| Dynamic ^b | | | | | | | |
| Input Capacitance | C _{iss} | | | 6550 | | pF | |
| Output Capacitance | C _{oss} | V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz | | 665 | | | |
| Reverse Transfer Capacitance | C _{rss} |] | | 265 | | | |
| Total Gate Charge ^c | Q_g | | | 105 | | | |
| Gate-Source Charge ^c | Q_{gs} | $V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 85 \text{ A}$ | | 17 | | nC | |
| Gate-Drain Charge ^c | Q_{gd} | 7 | | 23 | | | |
| Turn-On Delay Time ^c | t _{d(on)} | | | 12 | 25 | | |
| Rise Time ^c | t _r | $V_{DD} = 50 \text{ V}, R_{L} = 0.6 \Omega$ | | 90 | 135 | ns | |
| Turn-Off DelayTime ^c | t _{d(off)} | $I_D\cong 85~A,~V_{GEN}=10~V,~R_g=2.5~\Omega$ | | 55 | 85 | | |
| Fall Time ^c | t _f | 7 | | 130 | 195 | 1 | |
| Source-Drain Diode Ratings and Cha | racteristics T _C | = 25 °C ^b | | | | | |
| Continuous Current | I _S | | | 90 | | ^ | |
| Pulsed Current | I _{SM} | | | 240 | | Α | |
| Forward Voltage ^a | V_{SD} | I _F = 85 A, V _{GS} = 0 V | | 1.0 | 1.5 | V | |
| Reverse Recovery Time | t _{rr} | | | 85 | 140 | ns | |
| Peak Reverse Recovery Current | I _{RM(REC)} | I _F = 50 A, dI/dt = 100 A/μs | | 4.5 | 7 | Α | |
| Reverse Recovery Charge | Q _{rr} | 1 | | 0.17 | 0.35 | μC | |

Notes:

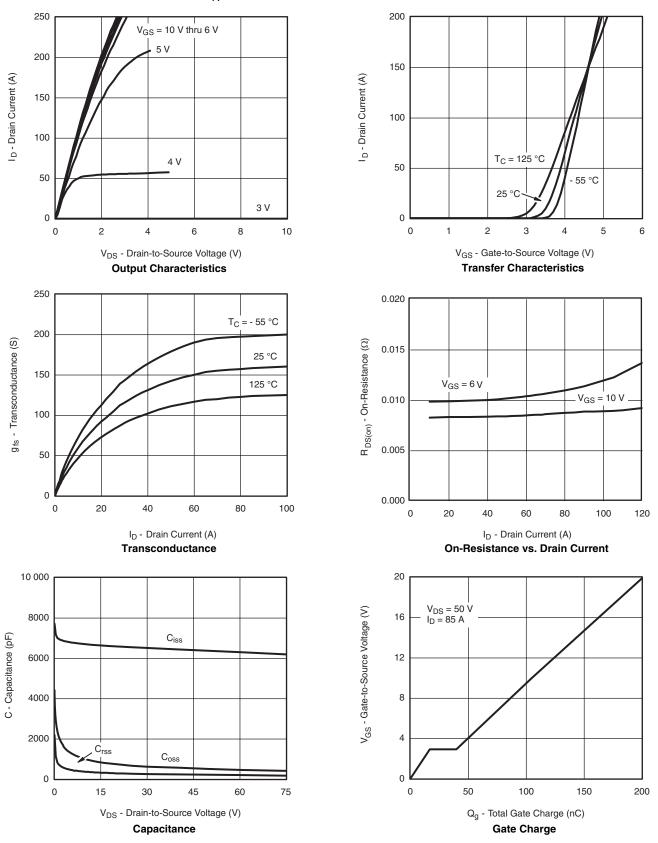
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- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



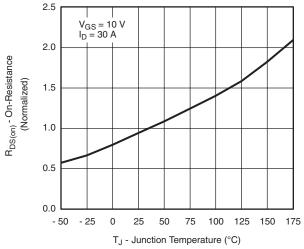
TYPICAL CHARACTERISTICS $T_A = 25 \, ^{\circ}C$, unless otherwise noted



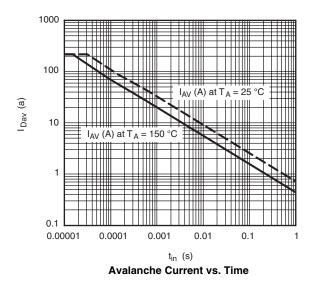
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TYPICAL CHARACTERISTICS $T_A = 25 \, ^{\circ}C$, unless otherwise noted

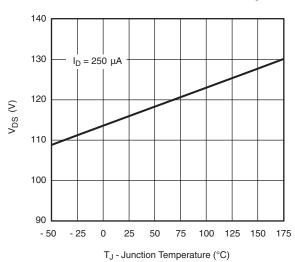


On-Resistance vs. Junction Temperature



T_J = 150 °C T_J = 25 °C T_J

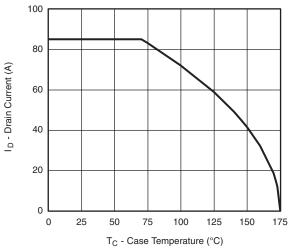
Source-Drain Diode Forward Voltage

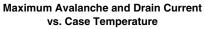


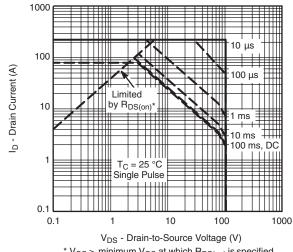
T_J - Drain-Source Breakdown vs. Junction-Temperature



THERMAL RATINGS

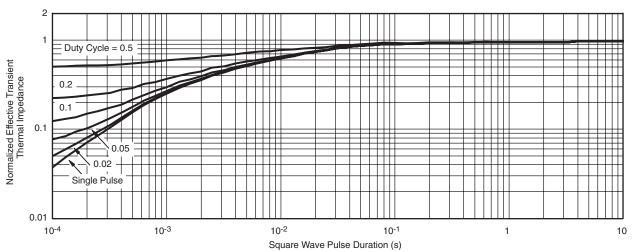






* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

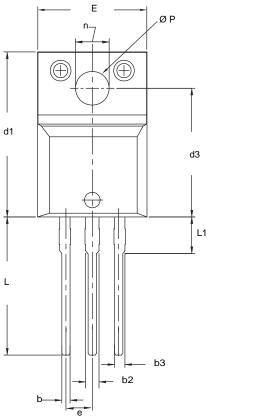
Safe Operating Area

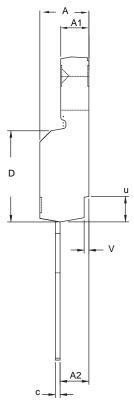


Normalized Thermal Transient Impedance, Junction-to-Case



TO-220 FULLPAK (HIGH VOLTAGE)





| DIM. | MILLIN | METERS | INCH | HES |
|------|----------|--------|-----------|-------|
| | MIN. | MAX. | MIN. | MAX. |
| Α | 4.570 | 4.830 | 0.180 | 0.190 |
| A1 | 2.570 | 2.830 | 0.101 | 0.111 |
| A2 | 2.510 | 2.850 | 0.099 | 0.112 |
| b | 0.622 | 0.890 | 0.024 | 0.035 |
| b2 | 1.229 | 1.400 | 0.048 | 0.055 |
| b3 | 1.229 | 1.400 | 0.048 | 0.055 |
| С | 0.440 | 0.629 | 0.017 | 0.025 |
| D | 8.650 | 9.800 | 0.341 | 0.386 |
| d1 | 15.88 | 16.120 | 0.622 | 0.635 |
| d3 | 12.300 | 12.920 | 0.484 | 0.509 |
| Е | 10.360 | 10.630 | 0.408 | 0.419 |
| е | 2.54 BSC | | 0.100 BSC |) BSC |
| L | 13.200 | 13.730 | 0.520 | 0.541 |
| L1 | 3.100 | 3.500 | 0.122 | 0.138 |
| n | 6.050 | 6.150 | 0.238 | 0.242 |
| ØΡ | 3.050 | 3.450 | 0.120 | 0.136 |
| u | 2.400 | 2.500 | 0.094 | 0.098 |
| V | 0.400 | 0.500 | 0.016 | 0.020 |

DWG: 5972

Notes

- To be used only for process drawing.
 These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads.
 All critical dimensions should C meet C_{pk} > 1.33.
 All dimensions include burrs and plating thickness.
 No chipping or package damage.



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